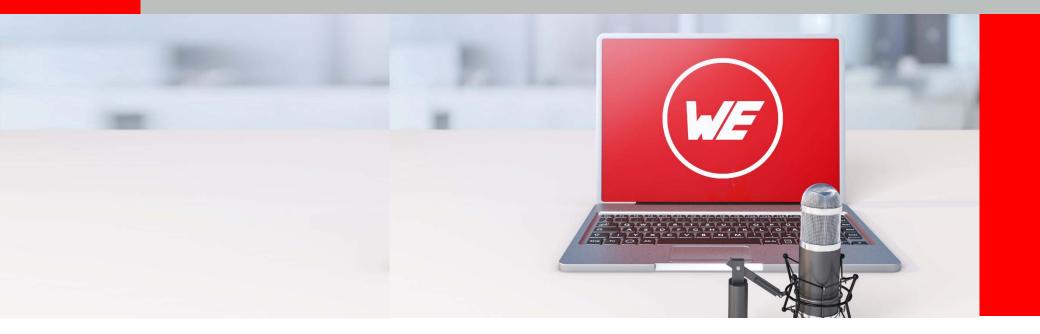


#### **USB 3.1** – a connector for multiple applications



Würth Elektronik Technical Academy Fabian Altenbrunn



### **Table of Content**



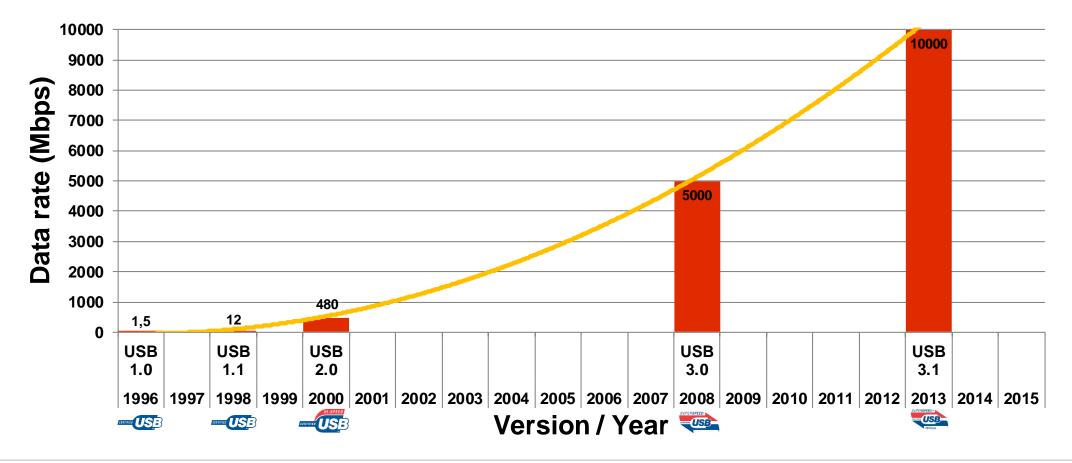
- History of USB and Evolution
- Electrical Performance
- Mechanical Performance
- Processability
- Conclusion



### A little bit of history – USB Versions



#### USB = <u>Universal</u> Serial Bus



## A little bit of history – From 2.0...





Year/Version

- A
- B
- Mini
- Micro

- Data rate
- Power









480 Mbps 500mA / 5V



## A little bit of history – ...to USB 3.0 ...



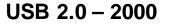


Year/Version

- A
- B
- Mini
- Micro

Data rate

Power







480 Mbps

500mA / 5V

USB 3.0 – 2008

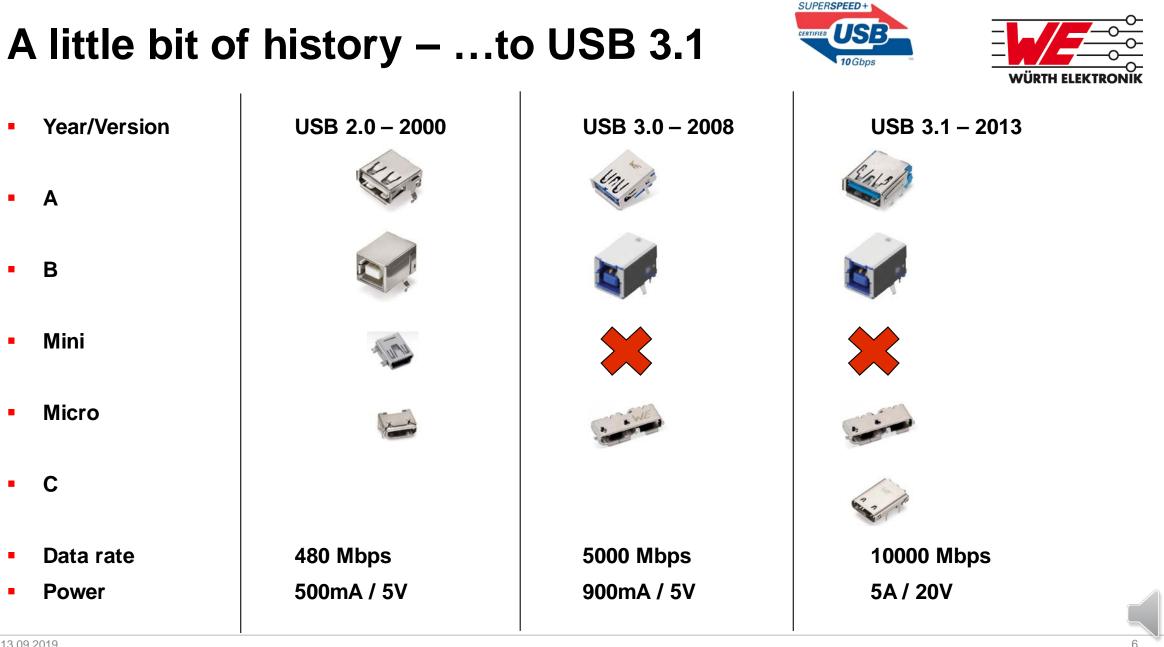




5000 Mbps 900mA / 5V



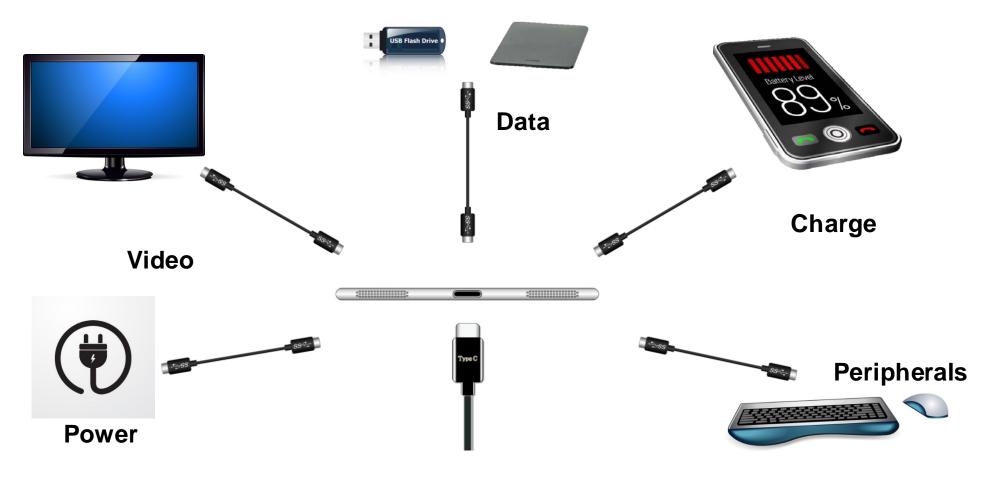




## **USB Type-C for All Connectivity**

First connector supporting power in both ways





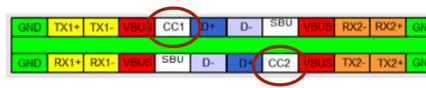
# **Configuration Channel**

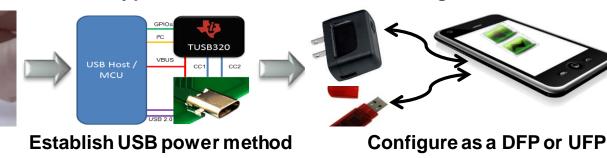
### Providing the flexibility of Type-C

- Functionally the Configuration Channel (CC) is used to serve the following purposes:
- Detect connect of USB ports,
- Resolve cable orientation and twist connections to establish USB data bus routing
- Establish DFP (sink) and UFP (source) roles between two connected ports

**Detect valid connection** 

- Discover and configure power: USB Type-C current modes or USB Power Delivery
- Discovery and configuration of optional Alternate and Accessory modes
  Typical CC flow for DFP to UFP configuration:





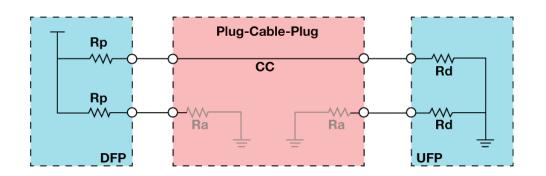
# **USB Power Delivery (PD)**

Extends USB Type-C capability – more power, Alt Mode, flexibility



#### What is USB PD?

- USB PD is a single wire communication protocol over CC lines
- A negotiation method to extend USB Type-C interface capability for more power, alt mode and flexibility
- Both ends must support certain extended feature(s) for an successful PD contract



#### Why USB PD?

- Extended Power
  - USB Type-C provides up to 15W (5V/3A) power through VBUS with simple resistor divider network
  - USB PD must be used to extend the power delivery beyond 5V/3A
  - PD can negotiate power up to 100W (20V/5A) faster charging
  - PD can also negotiate >1W of VCONN power up to 6W

#### Alternate Mode

- USB PD must be used for any Alt mode
- Through PD Alt Mode negotiation USB Type-C interface can be used for non-USB use cases
- SS differential pairs and SBU lines are available for Alt Mode use
- USB2 must be preserved when in Alt Mode
- Role Flexibility
  - By default Host/DFP is power source and Device/UFP is power sink
  - USB PD must be used to decouple the data/power roles

## **USB Type-C Power Modes**

Flexible and Modular Power Delivery Methods





USB Type-C can be used to deliver power via a number of different protocols:

Precedence	Mode of Operation	Nominal Voltage	Maximum Current
Highest	USB PD	Up to 20 V	Up to 5 A
T	USB Type-C current @ 3A	5 V	3 A
	USB Type-C current @ 1.5A	5 V	1.5 A
	USB BC1.2	5 V	Up to 1.5 A
	USB 3.1		900 mA
Lowest	USB 2.0		500 mA

#### **Port Power Roles**

SS←

Following the introduction of USB PD, port power roles are now defined separately from the port data roles.

- **Provider:** device can only provide power
- **Consumer:** device can only receive power
- Consumer provider: the device can act as either a consumer or provider. This is only possible for devices that support USB PD

# Capable of delivering up to 100W over one USB Type-C port!



# **USB PD Alternate Mode Negotiation**

Scope Trace between a Dock and Notebook establishing a USB PD Contract





# **Electronically Marked Cable**

Making USB Type-C interface ubiquitous

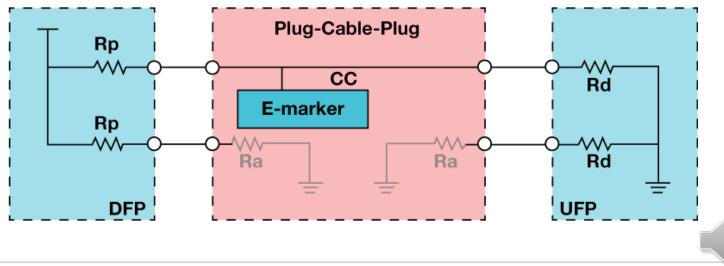


#### What is E-marker?

- Simple USB PD controller inside a cable
- Responds to USB PD commands from DFP/source
- Provide cable characteristics such as current carrying capability, performance, vendor identification etc.
- Typically powered by VCONN

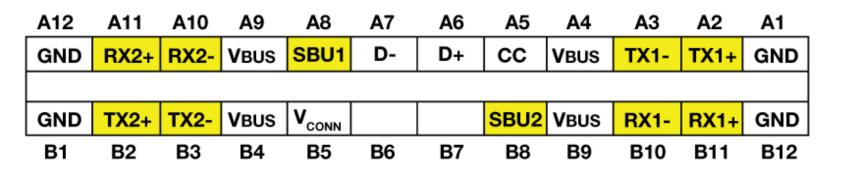
#### When E-marker is needed?

- USB Type-C cable supporting more than 3A current
- USB Type-C full featured cable with USB 3.1 or alternate mode signaling



## **USB Type-C Alternate Mode**

#### Extends beyond USB data



#### What is Alt Mode?

- Alternate use of USB Type-C interface for non-USB functions
- USB2 must be preserved
- USB PD must be used to negotiate an alternate mode
- Definition: Operation defined by a vendor or standards organization that is associated with a SVID assigned by the USB-IF. Entry and exit into and from an Alternate Mode is controlled by the USB PD Structured VDM Enter Mode and Exit Mode commands

#### **Example of Alt Modes**

- DisplayPort (DP)
- Thunderbolt
- PCI Express
- MHL
- HDMI (for dongle/adapters)

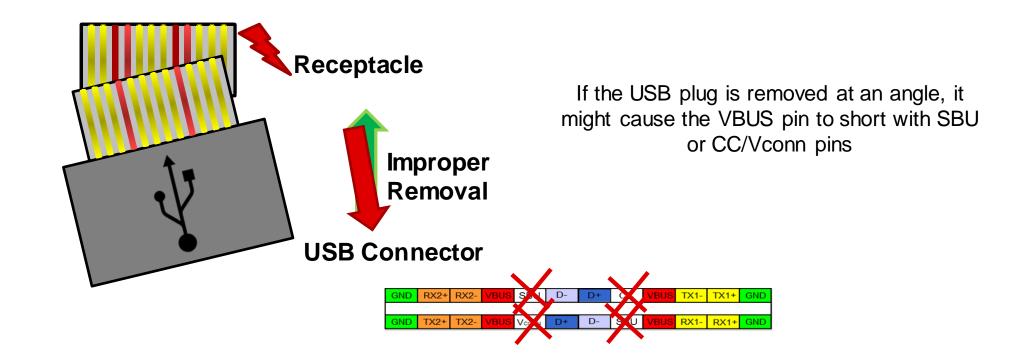
## Can you create your own alternate mode?

- Option 1: create an official alternate mode approved by USB-IF (will be given a SID, standard ID)
- Option 2: Get a VID from USB-IF and create a non-official alternate mode (you must own both sides of the system for this to work)



### **Potential Failure: Mechanical Twist**



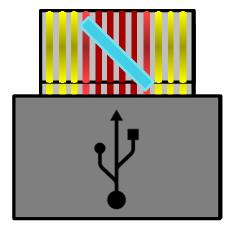




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### **Potential Failure: Debris or Water**





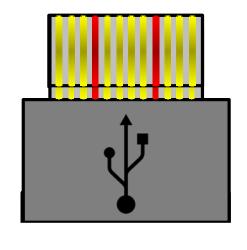
Any debris or water that is conductive could short the SBU and CC pins to the 20V Vbus lines





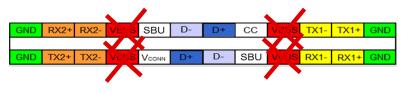
## **Potential Failure: Noncompliant Cables**







- Even if your system is not using USB PD (you are charging at 5V, 500mA), there are noncompliant cables that output 20V without PD negotiation
- If your system is not designed to handle 20V, then there would be a failure
- In a survey of USB Type-C cables available on Amazon, 28% of cables were not compliant to USB-IF specification. (Google Engineer Benson Leung: 20/71 cables out of specification)
- Despite Amazon's ban there is still a risk of end user's purchasing non-compliant USB Type-C cables from cable manufacturers



### **USB 3.1 Product Overview** Type C



USB Type-C<br/>ReceptacleUSB Type-C<br/>CableUSB Type-C<br/>Power-RedImage: CC-Blue<br/>Power Return - Tin Plated<br/>SBU Red & Black<br/>USB 2.0 White & GreenImage: CC-Blue<br/>Power Return - Tin Plated<br/>SBU Red & Black<br/>VCONN - YellowImage: CC-Blue<br/>Power Return - Tin Plated<br/>SBU Red & Black<br/>VCONN - Yellow

OD = 4.8mm Coax are SS pairs – specific pairs not defined in cable

#### Figure 2-1 USB Type-C Receptacle Interface (Front View)

A1	A2	A3	A4	A5	A6	A7	A8	A9	A10	A11	A12
GND	TX1+	TX1-	VBUS	CC1	D+	D-	SBU1	VBUS	RX2-	RX2+	GND
GND	RX1+	RX1-	VBUS	SBU2	D-	D+	CC2	VBUS	TX2-	TX2+	GND
B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1

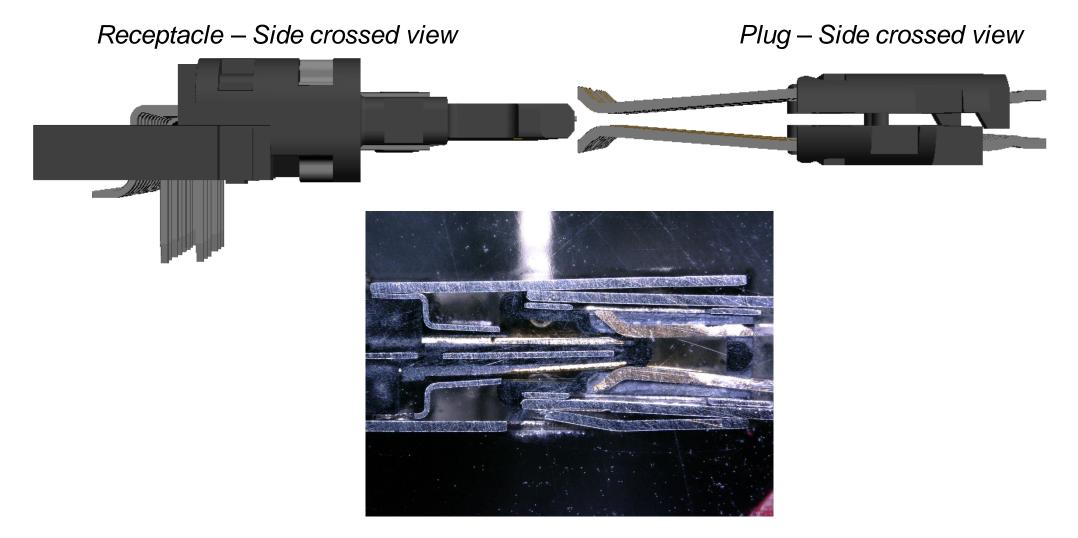
#### Figure 2-2 USB Full-Featured Type-C Plug Interface (Front View)

A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1
GND	RX2+	RX2-	VBUS	SBU1	D-	D+	сс	VBUS	TX1-	TX1+	GND
GND	TX2+	TX2-	VBUS	VCONN			SBU2	VBUS	RX1-	RX1+	GND
B1	B2	B3	В4	B5	B6	B7	B8	B9	B10	B11	B12

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### USB 3.1 Product Overview Type C Plug Design – 632 712 000 011



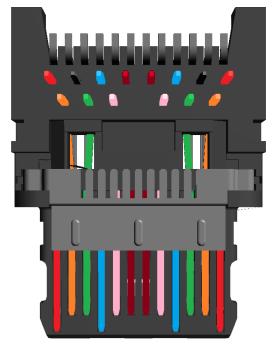


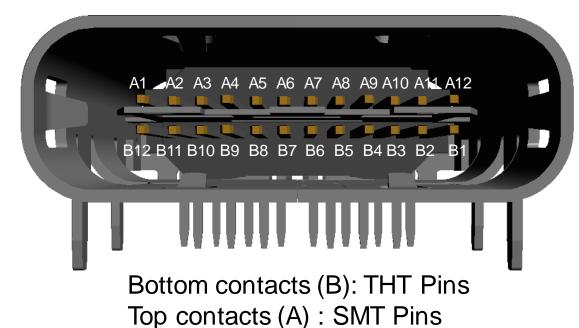
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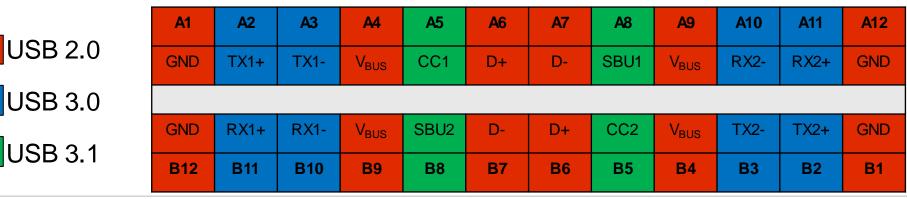
## **USB 3.1 Product Overview**

Type C Receptacles Design – 632 723 x00 011









## **Type C Receptacles**

- Order code:
  - $\ \ 632\ 723\ X00\ 011$

#### Product features:

- Material: LCP; black
- Rated Current: 5 A
- Rated Voltage: 5 VDC (12VDC/20VDC)
- Durability: 10 000 cycles
- Soldering: JEDEC lead free wave and reflow soldering
- Order code:
  - $\ \ 632\ 723\ X30\ 112$

X	PCB Thickness	Pin length
1	1.60 mm	1.60 mm





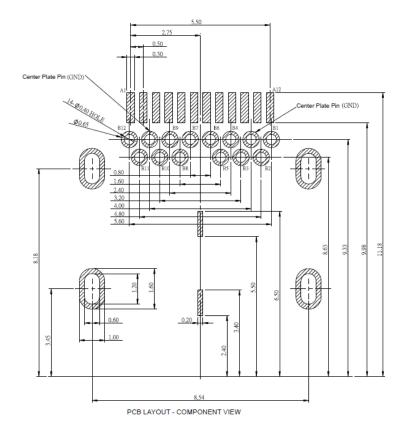


### Layout PCB – horizontal USB-C 3.1



Footprint X2\_632723300011 

#### **PCB** Layout

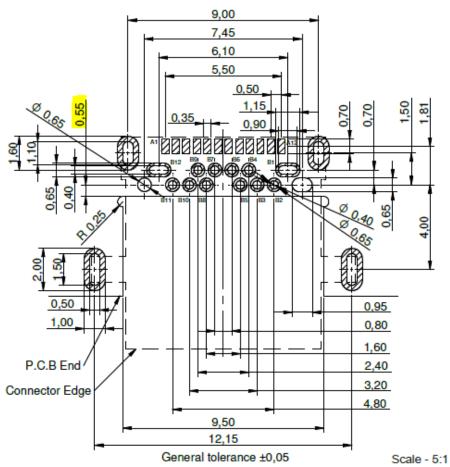


### Layout PCB – mid mount



Attention: Distance from center PIN to the upper edge of the milling track.

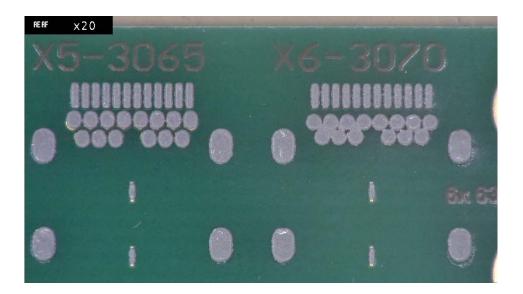
Distance center-pin to center-milling track is 0.55mm + the radius of the milling cutter (0.25mm) equal to 0.80mm.



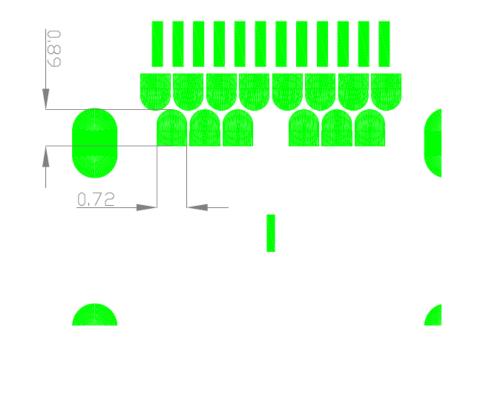
### **Pasteprinting & Stencil**



#### left Solderpad diameter: 0,65mm right Solderpad diameter: 0,70mm



#### **Stencil example**

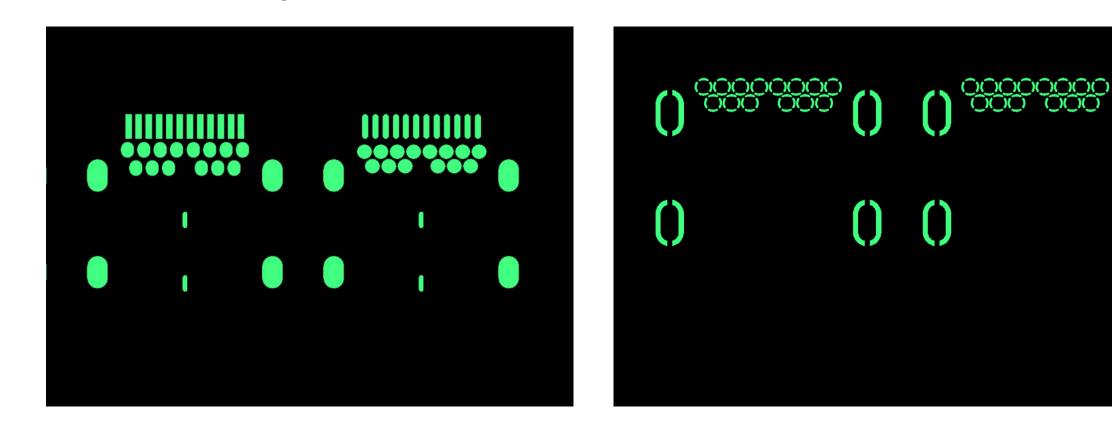


### **Pasteprinting & Stencil**



**Top View** 

#### **Bottom View**

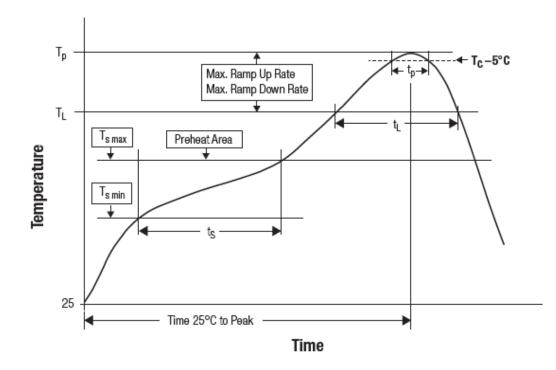




## Solderingprofile



#### **Classification Reflow Profile for SMT components:**



#### **Classification Reflow Soldering Profile:**

Profile Feature		Value
Preheat Temperature Min <sup>1)</sup>	T <sub>s min</sub>	150 °C
Preheat Temperature Max	T <sub>s max</sub>	200 °C
Preheat Time ${\rm t_s}$ from ${\rm T_s}_{\rm min}$ to ${\rm T_s}_{\rm max}$	t <sub>s</sub>	60 - 120 seconds
Ramp-up Rate (T <sub>L</sub> to T <sub>P</sub> )		3 °C/ second max.
Liquidous Temperature	Τ <sub>L</sub>	217 °C
Time $t_L$ maintained above $T_L$	ť	60 - 150 seconds
Peak package body temperature	Tp	see table
Time within 5°C of actual peak temperaure	tp	20 - 30 seconds
Ramp-down Rate (T <sub>L</sub> to T <sub>P</sub> )		6 °C/ second max.
Time 25°C to peak temperature		8 minutes max.
4		

1) refer to IPC/JEDEC J-STD-020D refer to IPC/ JEDEC J-STD-020E

#### Package Classification Reflow Temperature:

Properties	Volume mm³ <350	Volume mm³ 350-2000	Volume mm³ >2000
PB-Free Assembly   Package Thickness < 1.6 mm <sup>1)</sup>	260 °C	260 °C	260 °C
PB-Free Assembly   Package Thickness 1.6 mm - 2.5 mm	260 °C	250 °C	245 °C
PB-Free Assembly   Package Thickness $\ge$ 2.5 mm	250 °C	245 °C	245 °C

1) refer to IPC/JEDEC J-STD-020D refer to IPC/ JEDEC J-STD-020E

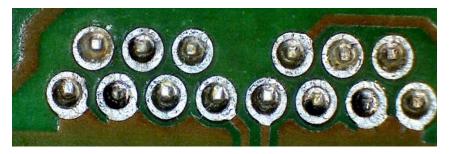
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## **Soldering Examples**





#### Soldering without defects



#### Soldering with defects



Handsoldering

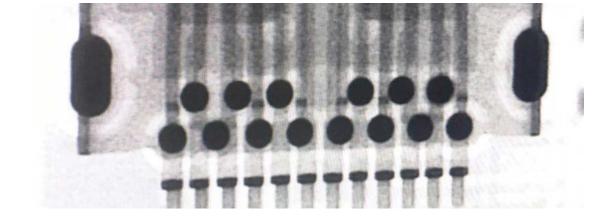


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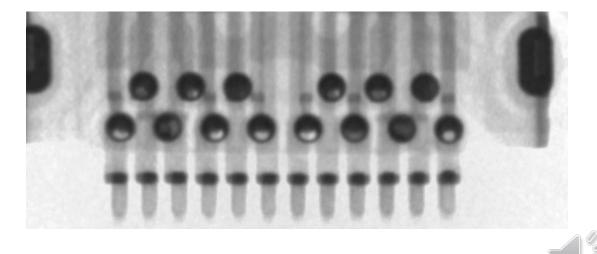
## **Soldering inspection via X-Ray**

Solderingresult without defects



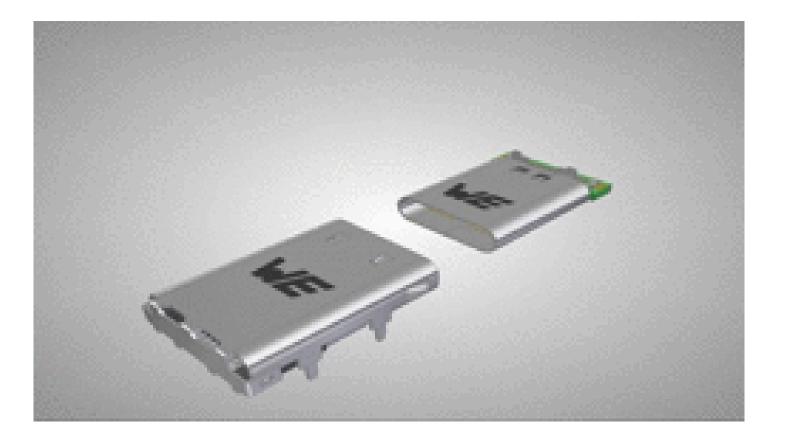






## Type C Plug – 632 723 x00 011





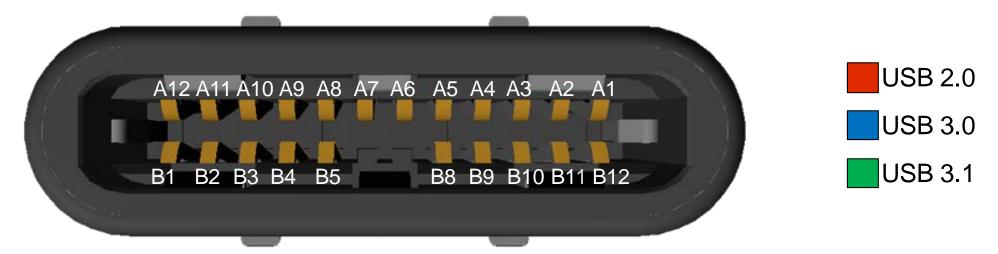


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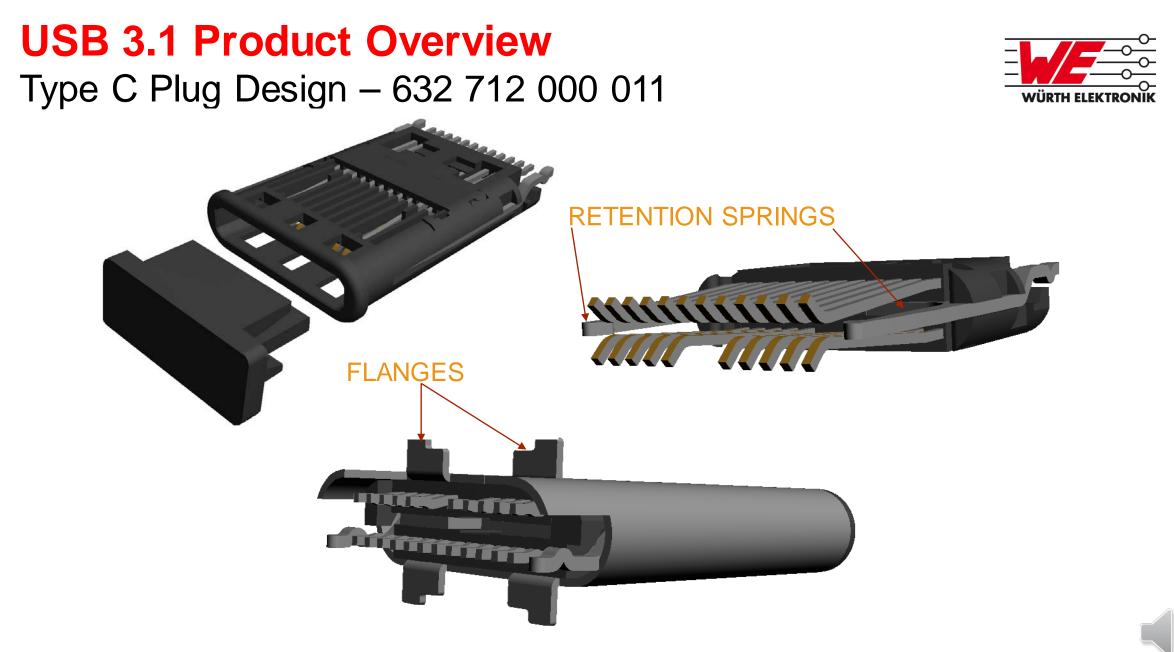
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### Type C Plug – 632 712 000 011





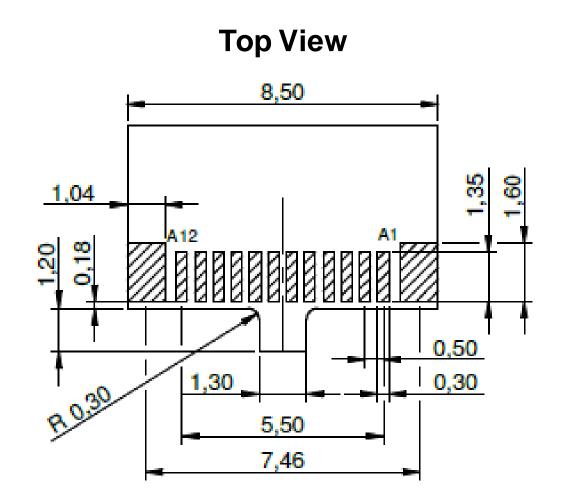
A12	A11	A10	<b>A9</b>	<b>A8</b>	A7	<b>A6</b>	A5	A4	A3	A2	A1
GND	RX2	RX2-	V <sub>BUS</sub>	SBU	D+	D-	CC1	V <sub>BUS</sub>	TX1-	TX1+	GND
	+			1							
GND	TX2+	TX2-	VPUS	CC2			SBU	V <sub>BUS</sub>	RX1-	RX1	GND
			000				2	000		+	
<b>B1</b>	<b>B2</b>	<b>B</b> 3	<b>B4</b>	B5			<b>B</b> 8	<b>B</b> 9	B10	B11	B12



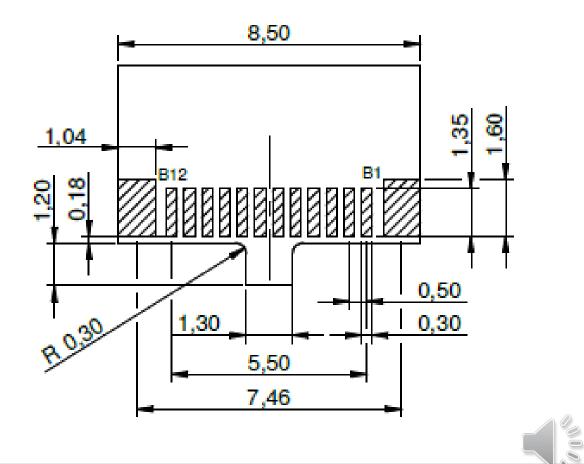
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## Layout PCB



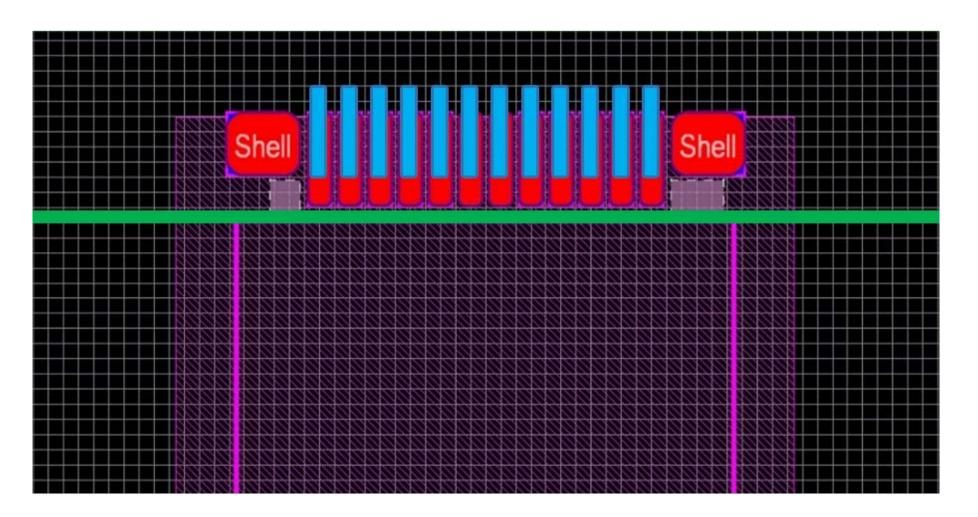


#### **Bottom View**



## **Pasteprinting & Stencil**



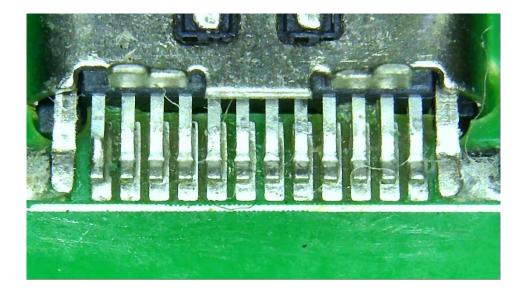


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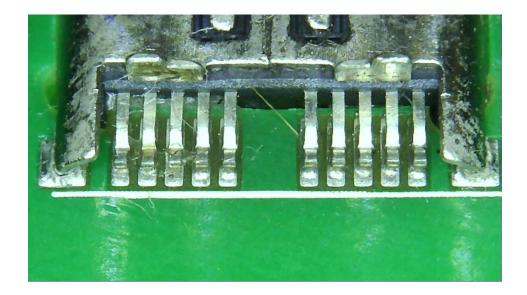
## **Soldering Example**



#### Top side view



#### Bottom side view

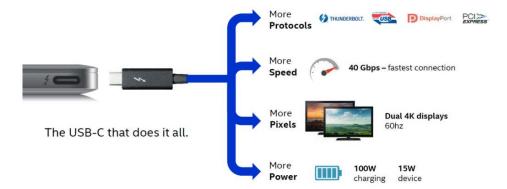




## Conclusion



#### Thunderbolt<sup>™</sup> 3 Brings Thunderbolt to USB-C



#### Mechanical Performance:

- 10.000 mating cycles
- High extraction (retention) force
- Long time reliability
- Time saving (only one type of connector is needed)
- Space saving

#### RF Behaviour:

- high data rate (over 10GHz)
- EMC / EMI protection
- mix mode is possible
- (e.g. USB 2.0 & I<sup>2</sup>C; USB 2.0 DC/DC controller)

Electrical Performance:

- 5V / 12V / 20V
- up to 5A

and

- PD (up to 100W)



### Thank you !





#### We are here for you now ! Ask us directly in the chat!

You can also contact us after the session:



eisos-webinar@we-online.com

Fabian.Altenbrunn@we-online.de

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